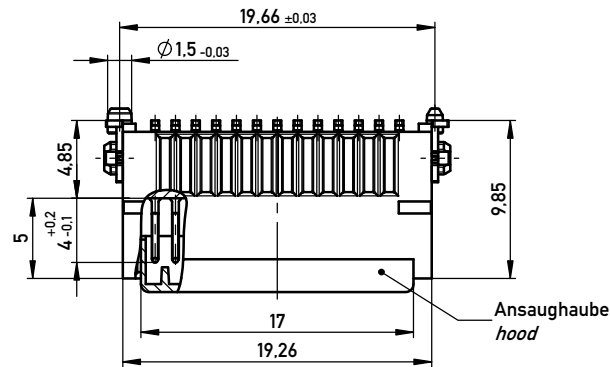
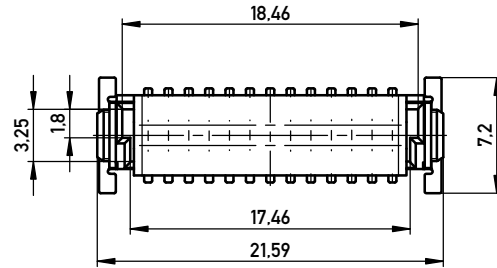
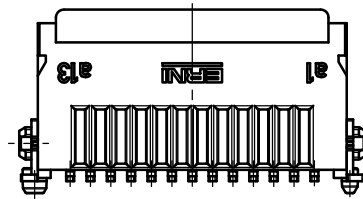
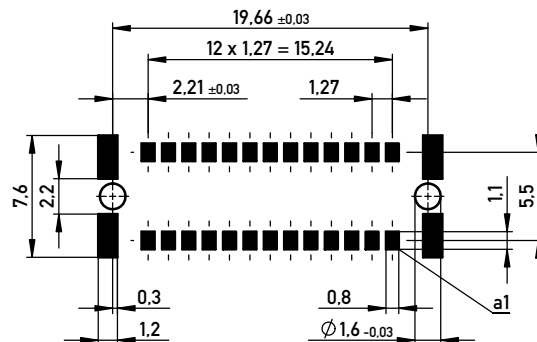
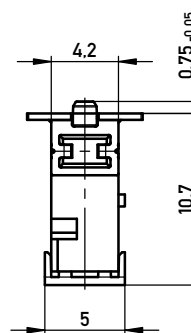
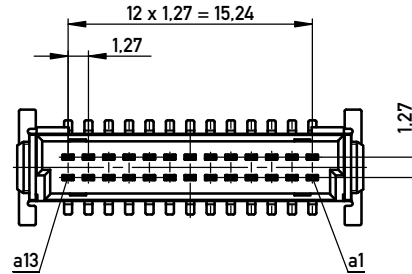




Leiterplatten-Layout Vorschlag für SMT PCB-Layout Proposal for SMT



ohne Ansaughaube - without hood



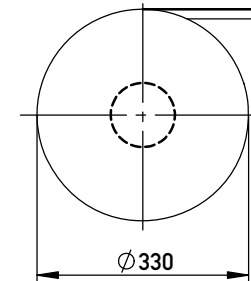
Anforderungsstufe 1
Performance Level 1

Kontaktbereich vergoldet
Mating Area gold plating

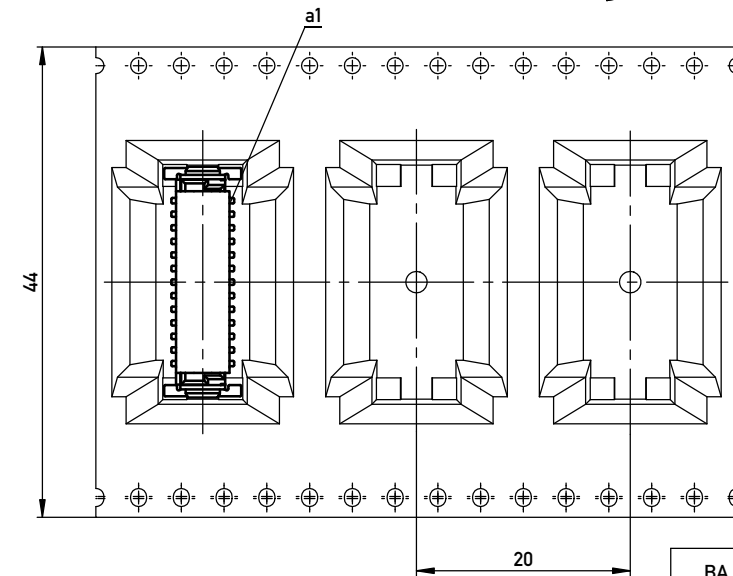
Anschlussbereich verzinkt 4-6 µm
Terminal Area 4-6 µm tin plating

Koplanarität der Anschlüsse ≤ 0.1 mm
Coplanarity Area of Termination ≤ 0.1 mm

Verpackt im Gurt nach DIN IEC 60286-3
Tape on Reel Packaging according to DIN IEC 60286-3
Verpackungseinheit: 250 Stück
Packaging unit: 250 pcs



Abspulrichtung - Reel off Direction



BA 8-23 - hohe Bauhöhe
type 8-23 - High Profile

Proprietary notice pursuant to ISO 9001 to be observed.

Information:			Tolerances		 All Dimensions in mm		Scale 3:1			
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						Messerl. SMC-Q 26-SMD-BA8-23 <i>Male SMC-Q 26-SMD-type8-23</i>				
			ERNI			www.ERNI.com		234207		
e		26.06.2015							A3	
Index		Date				Class			SMCQ	

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